

Features

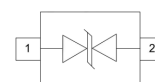
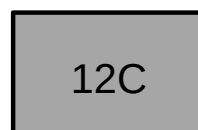
350 W (8x20us) Peak Pulse Power
Low Clamping Voltage
SOD-323 Package
RoHS Compliant
Matte Tin Lead finish (Pb-Free)
Protect One I/O or Power Line
Meet IEC61000-4-2 Level 4:
Contact Discharge > 30 kV
Air Discharge > 30 kV

Applications

Smart Phones
Laptop Computers
Portable Electronics

Mechanical Data

Package: SOD-323
Lead Finish: Matte Tin
Case Material: "Green" Molding Compound
UL Flammability Classification Rating 94V-0
Moisture Sensitivity: Level 3 per J-STD-020
Terminal Connections: See Diagram Below



SOD-323

Absolute Maximum Rating

Parameter	Symbol	Limit	Unit
IEC 61000-4-2 ESD Voltage	$V_{ESD}^{(1)}$	±30	kV
		±30	
		±16	
		±0.4	
Peak Pulse Power	$P_{PP}^{(2)}$	350	W
Peak Pulse Current	$I_{PP}^{(2)}$	10	A
Lead Solder Temperature – Maximum (10 Second Duration)	T_L	260	°C
Junction Temperature	T_J	150	°C
Storage Temperature Range	T_{stg}	-55 ~ +150	°C

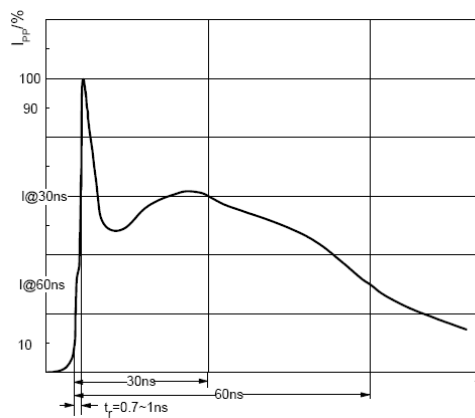
(1). Device stressed with ten non-repetitive ESD pulses.

(2). Non-repetitive current pulse 8/20μs exponential decay waveform according to IEC61000-4-5.

ESD standards compliance

IEC61000-4-2 Standard

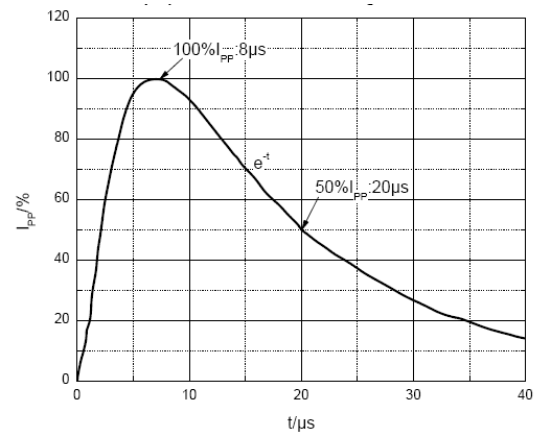
Contact Discharge		Air Discharge	
Level	Test Voltage kV	Level	Test Voltage kV
1	2	1	2
2	4	2	4
3	6	3	8
4	8	4	15



ESD pulse waveform according to IEC61000-4-2

JESD22-A114-B Standard

ESD Class	Human Body Discharge V
0	0~249
1A	250~499
1B	500~999
1C	1000~1999
2	2000~3999
3A	4000~7999
3B	8000~15999

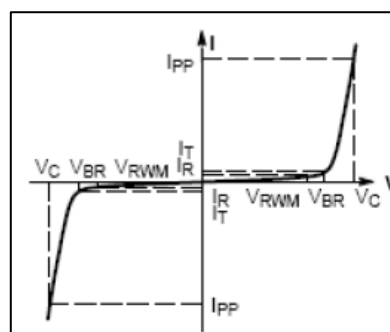


8/20 μ s pulse waveform according to IEC 61000-4-5

Electrical Characteristics (Ta = 25°C)

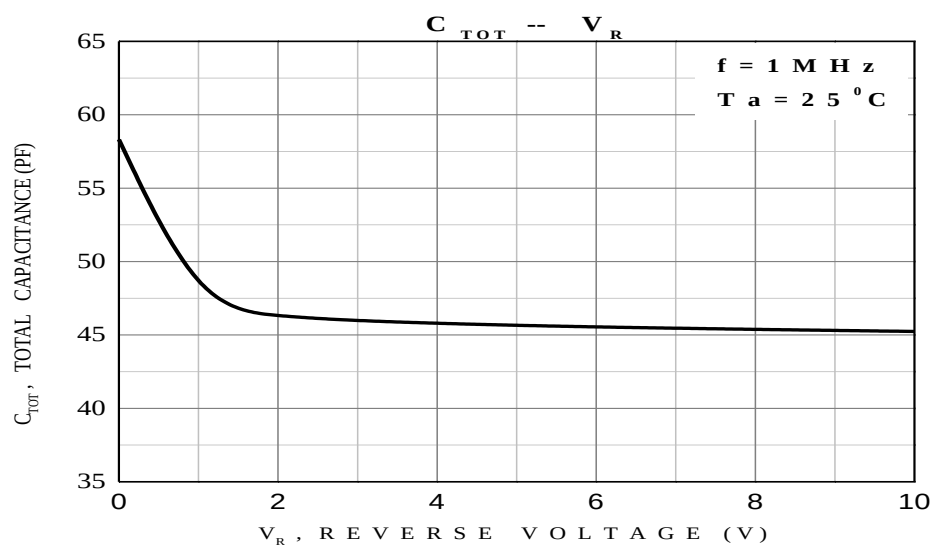
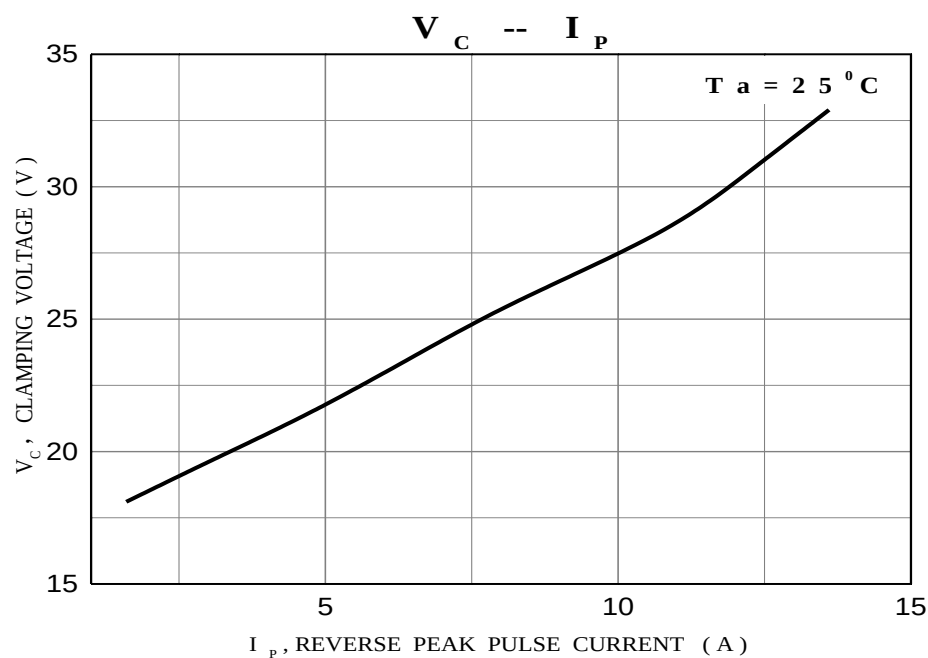
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
VRWM	Reverse Working Peak Voltage				12	V
VBR	Reverse Breakdown Voltage	IT = 1mA	13.6		16	V
IR	Reverse Leakage Current	VRWM = 12 V			1	μA
VC	Clamping Voltage	I _{PP} = 1 A (8/20μs)			25	V
VC	Clamping Voltage	I _{PP} = 1.0 A (8/20μs)			35	V
I _{pp}	Peak Pulse Current	μs) t _p = 8/20μs			10	A
CJ	Capacitance	VR = 0V, f = 1MHz		60		pF

Symbol	Parameter
VC	Clamping Voltage @ I _{PP}
I _{PP}	Peak Pulse Current
V _{BR}	Breakdown Voltage @ I _T
I _T	Test Current
I _R	Reverse Leakage Current @ V _{RWM}
V _{RWM}	Reverse Standoff Voltage



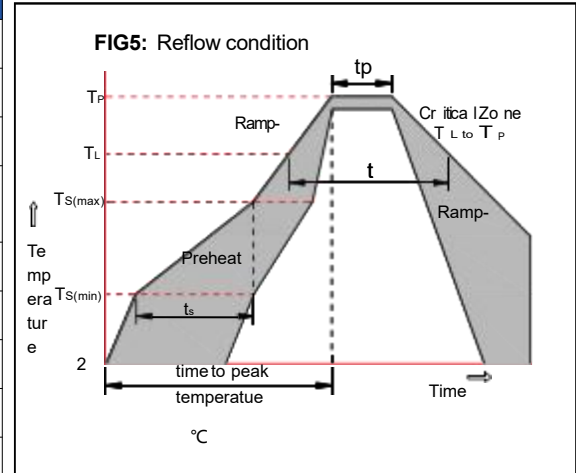
V-I characteristics for a Bi-directional TVS

RATING AND CHARACTERISTIC CURVES



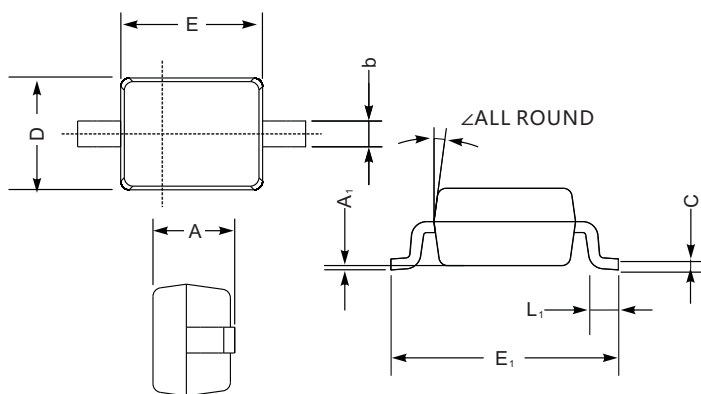
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C



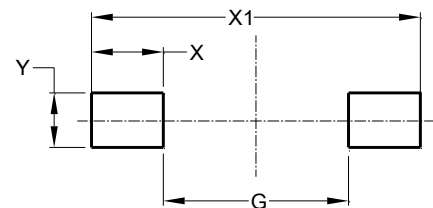
Package Dimensions & Suggested Pad Layout

SOD323



SOD-323 mechanical data

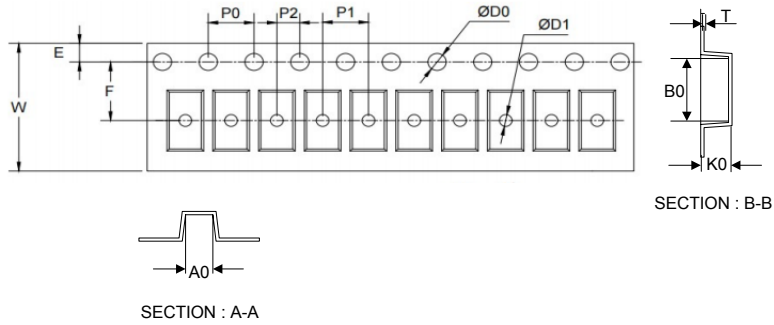
UNIT		A	C	D	E	E ₁	b	L ₁	A ₁	∠
mm	max	1.1	0.15	1.4	1.8	2.75	0.4	0.45	0.2	9°
	min	0.8	0.08	1.2	1.4	2.55	0.25	0.2	—	
mil	max	43	5.9	55	70	108	16	16	8	
	min	32	3.1	47	63	100	9.8	7.9	—	



Dimensions	Value (in mm)
G	1.40
X	1.20
X1	3.80
Y	1.00

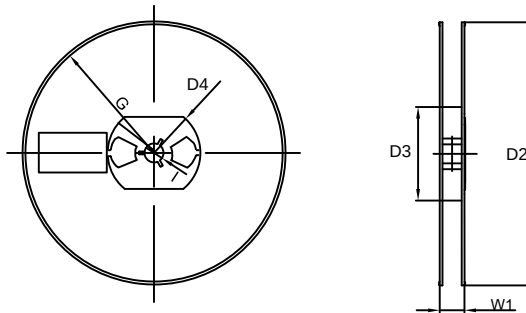
Tape & reel specification

Tape



Symbol	Dimension (mm)
P0	4.00±0.20
P1	4.00±0.20
P2	2.00±0.20
D0	1.55±0.20
D1	1.00±0.20
E	1.55±0.25
F	3.60±0.20
W	8.00±0.20
A0	2.00±0.20
B0	3.25±0.20
K0	1.35±0.20
T	0.23±0.10
D2	177.0±5.0
D3	55Min.
D4	R24.6±2.0
G	R82.0±2.0
I	13.0±2.0
W1	10.20±3.0

7" Reel



Quantity: 3000PCS